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To the Honorable Commissioner of Patents

ad original documents or copy thereof.

1. Name of conveying party(ies):

TAO, Su

8-6-01

2. Name and address of receiving party(ies):

Name: Advanced Semiconductor Engineering, Inc.

Internal Address: _____

Street Address: No. 26, Chin 3rd Road, Nantze ExportProcessing Zone, Kaoshiung, Taiwan, R.O.C.

City: _____ State: _____ ZIP: _____

Additional name(s) & address(es) attached? ☐ Yes ☒ No

Additional names(s) of conveying party(ies)

☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other _____Execution Date: 18 July 2001

4. Application number(s) or registration numbers(s):

If this document is being filed together with a new application, the execution date of the application is: 18 July 2001

A. Patent Application No.(s)

09/921,890

B. Patent No (s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: LAWRENCE R. RADANOVIC, Reg. No. 23,077Internal Address: DYKEMA GOSSETT PLLCFRANKLIN SQUARE 300 WESTStreet Address: 1300 I STREET, N.W.City: WASHINGTON State: DC ZIP: 200056. Total number of applications and patents involved: 17. Total fee (37 CFR 3.41): \$ 40.00☐ Enclosed - Any excess or insufficiency should be credited or debited to deposit account☒ Authorized to be charged to deposit account

8. Deposit account number:

04-2223

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

LAWRENCE R. RADANOVIC

Name of Person Signing

Signature

6 AUGUST 2001

Date

Total number of pages including cover sheet, attachments, and document: 2

Docket No.: 66382-23**ASSIGNMENT**

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

(1) Su TAO (4) _____
(2) _____ (5) _____
(3) _____ (6) _____

who have made a certain new and useful invention, hereby sell, assign and transfer unto

Advanced Semiconductor Engineering, Inc.

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

METHOD OF DICING A WAFER FROM THE BACK SIDE SURFACE THEREOF

(a) for which an application for United States Letters Patent was filed on _____, and identified by United States Serial No. _____; or

(b) for which an application for United States Letters Patent was executed on July 18, 2001

and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside our signatures:

INVENTORS**DATE SIGNED**

1) Signature: Su TAO
Name: Su TAO
2) Signature: _____
Name: _____
3) Signature: _____
Name: _____
4) Signature: _____
Name: _____
5) Signature: _____
Name: _____
6) Signature: _____
Name: _____

July 18, 2001

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